

プラズマ光源関連イオンのEBITによる分光

Emission spectroscopy of multiply charged ions
related to plasma light sources with an EBIT

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2012年度 原子分子データ応用フォーラムセミナー

2012 年 12 月 11-13 日

核融合科学研究所, 土岐市, 岐阜県

Outline

- ***Experimental setup***
 - **Electron beam ion trap (EBIT)**
 - EUV spectrometer
- ***Motivation & Results and discussion for...***
 - **Sn ions**
 - Semiconductor photo-lithography
 - Extreme ultra-violet (**EUV**) **lithography**
 - **Gd ions**
 - **Beyond** EUV lithography
 - **Bi ions**
 - **Water window**, Live cell imaging

 - ***EBIT emission spectra***
 - Comparison with other emissions and Calc. (FAC)
- ***Summary and Outlook***

Principle of an EBIT

(Electron Beam Ion Trap)

Penning-like ion trap
+
High density electron beam

→ **Successive ionization**

- **Ion trap**

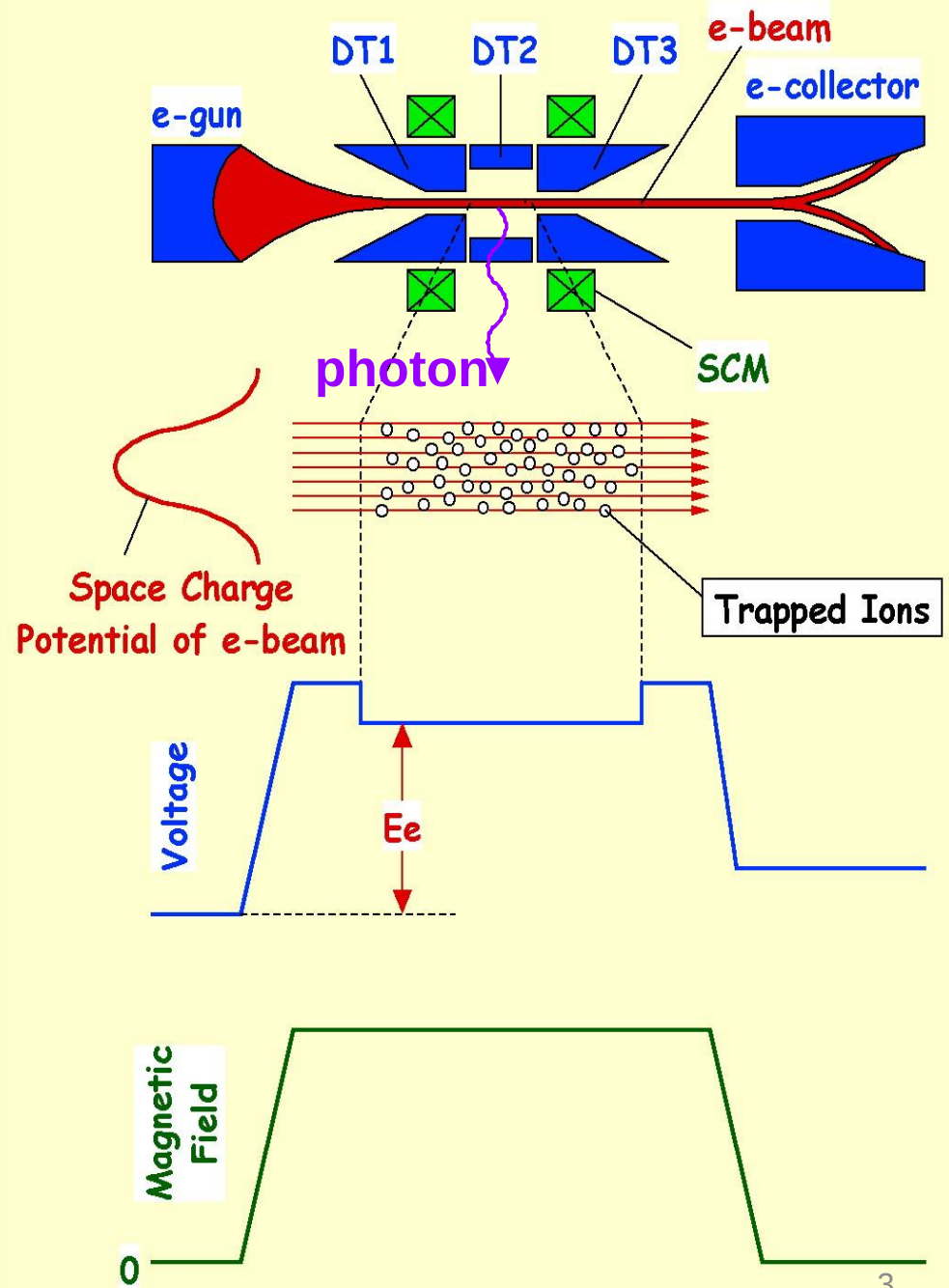
Well-type potential (DT1,2,3)
+ Space charge (e-beam)

- **High density electron beam**

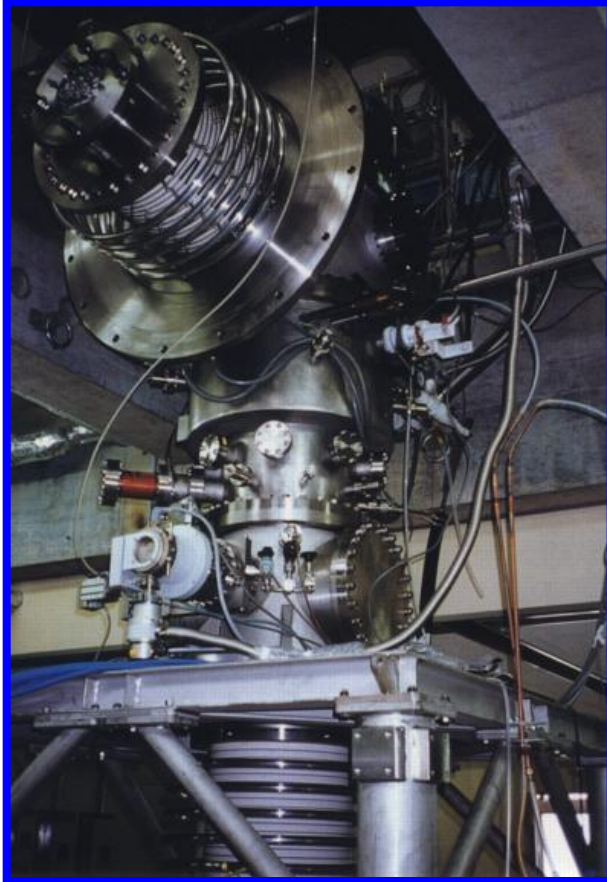
Superconductive magnets

- **Emission spectroscopy**

- **Ion extraction; collision expt.**



Two EBITs at UEC Tokyo



Tokyo-EBIT
since 1995



CoBIT
since 2007

Tokyo-EBIT

e-beam energy : **1 – 180 keV**

e-beam current : 330 mA (max)

Magnetic field : 4.5 T (max)

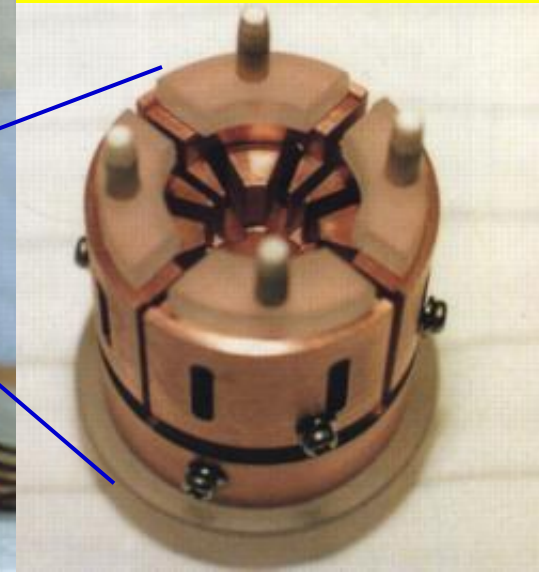
Cryostat temp. : 4.2 K (**LHe**)



Ion trap

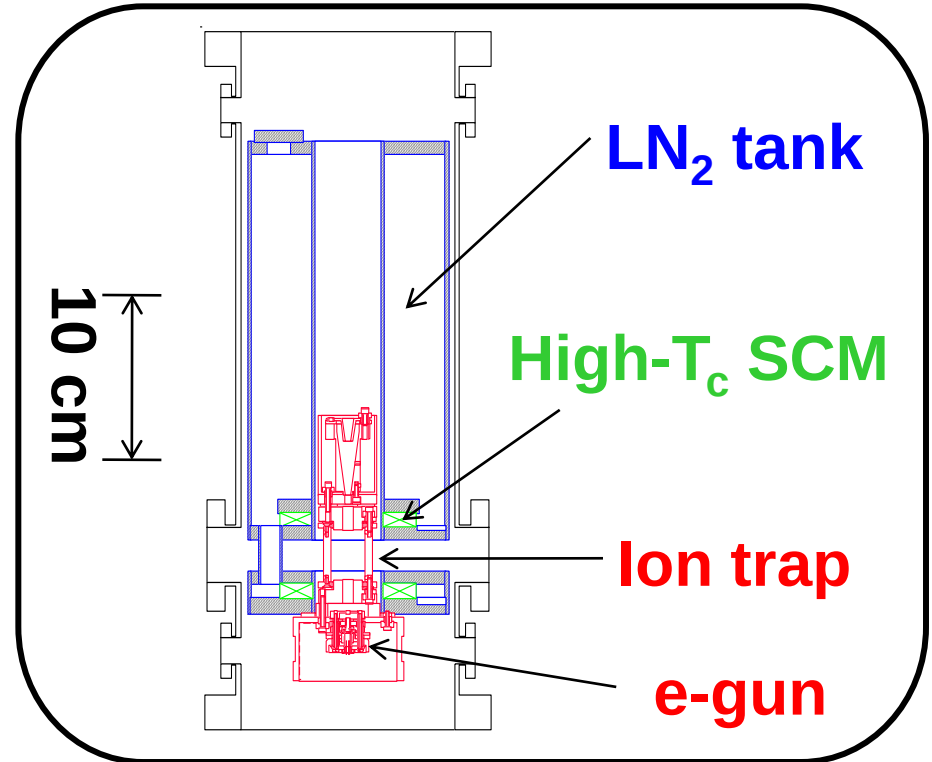


Middle of the trap



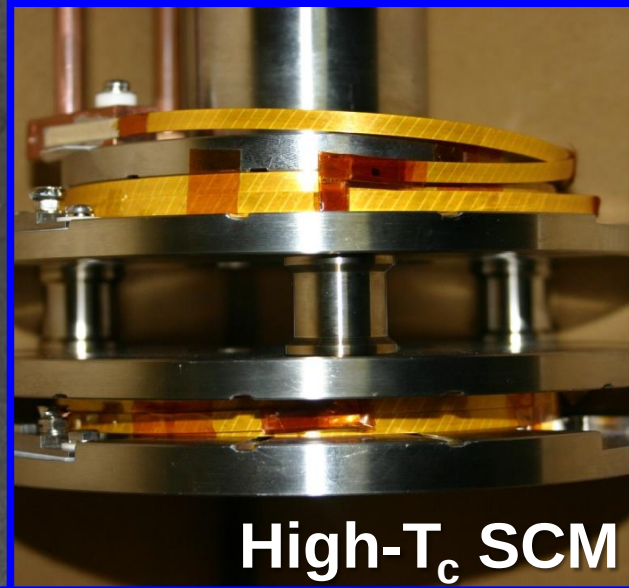
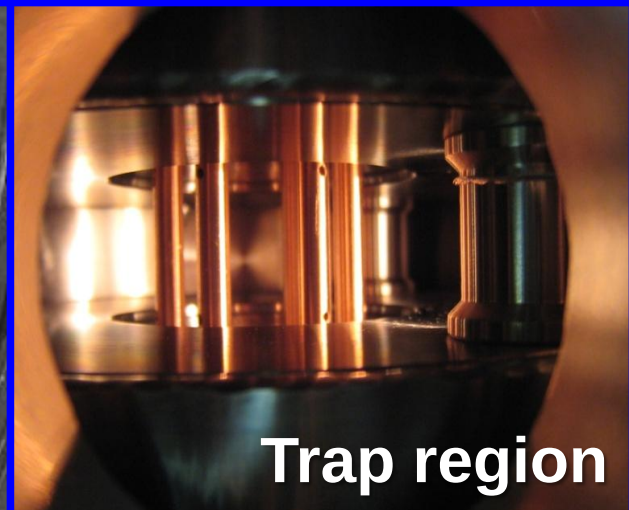
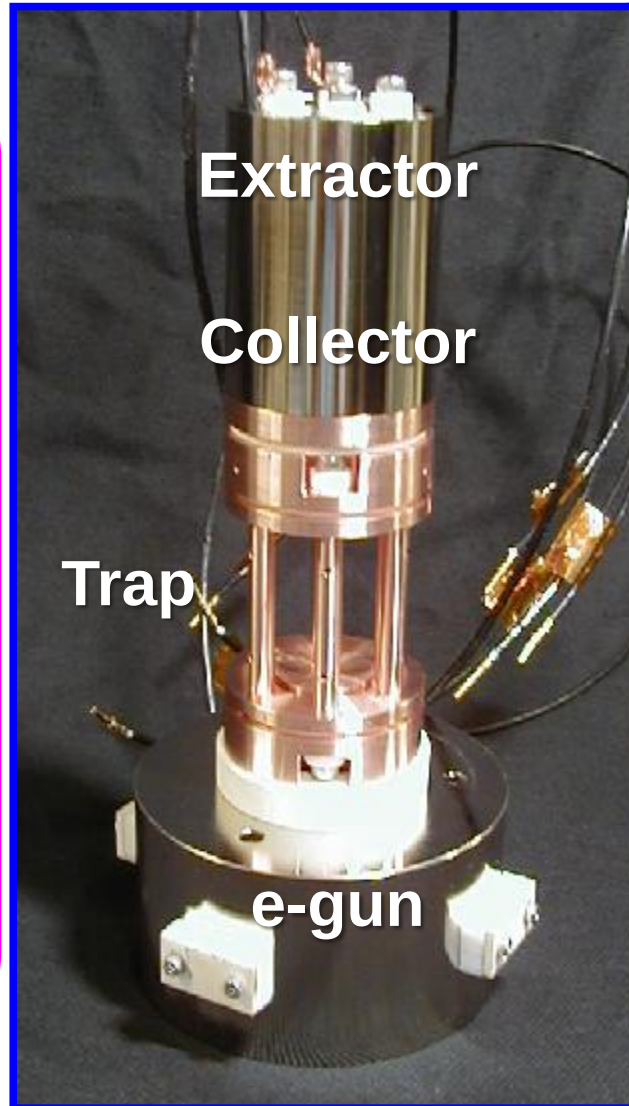
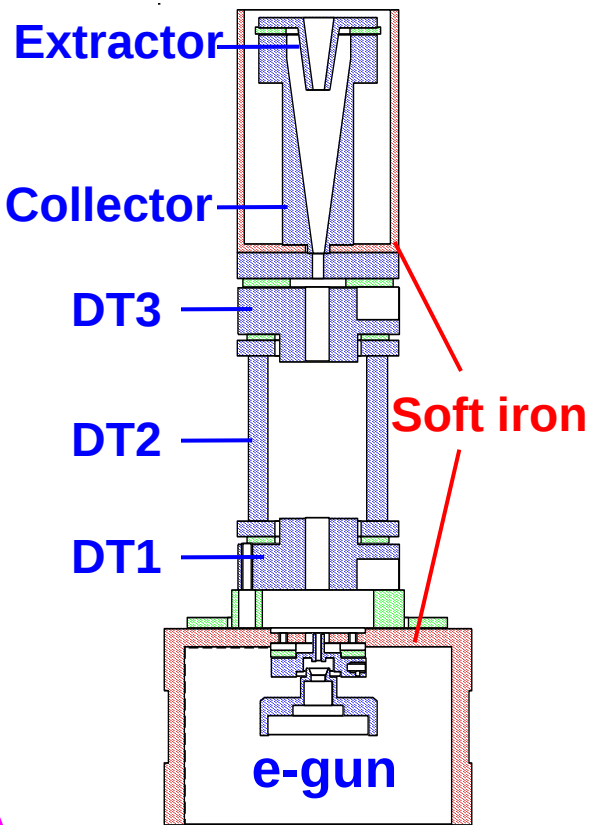
CoBIT (Compact, Corona, ... EBIT)

N. Nakamura et al., Rev. Sci. Instrum., 79 (2008) 063104



e-beam energy : **0.1 – 2 keV**
e-beam current : 20 mA (max)
Magnetic field : 0.2 T (max)
Cryostat temp. : 77 K (LN₂)

The core of CoBIT

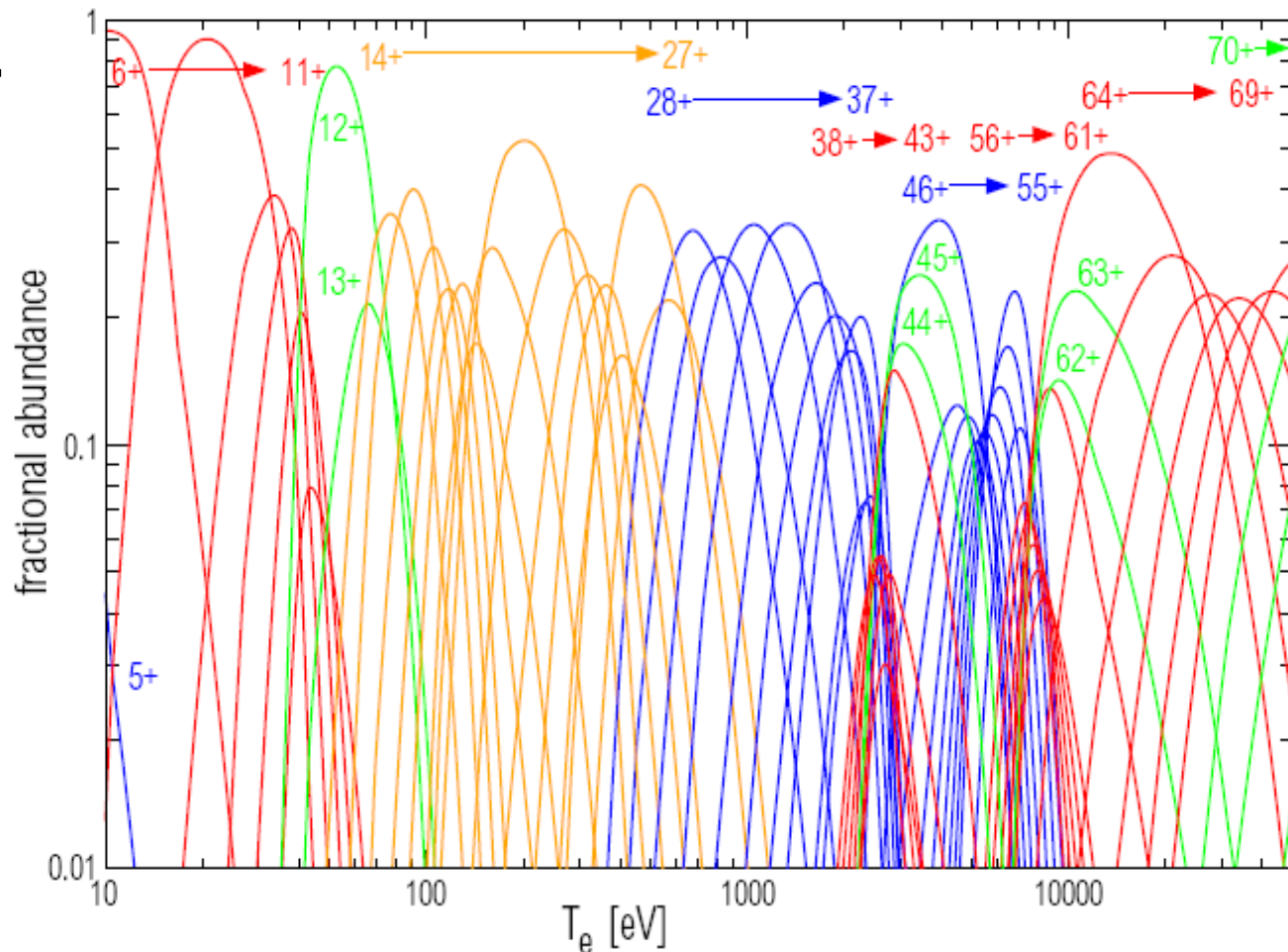


Comparison between two EBITs

	Tokyo-EBIT	CoBIT
e-beam energy / keV	1 – 180	0.1 – 2
e-beam current (max) / mA	330	20
Magnetic field (max) / T	4.5 (typically 4.0)	0.2 (typically < 0.1)
Cryostat temp. / K	4.2	77
Coolant	LHe	LN ₂
Height / m	~ 4	~ 0.4

Fractional abundance in hot plasmas

$Wq+$



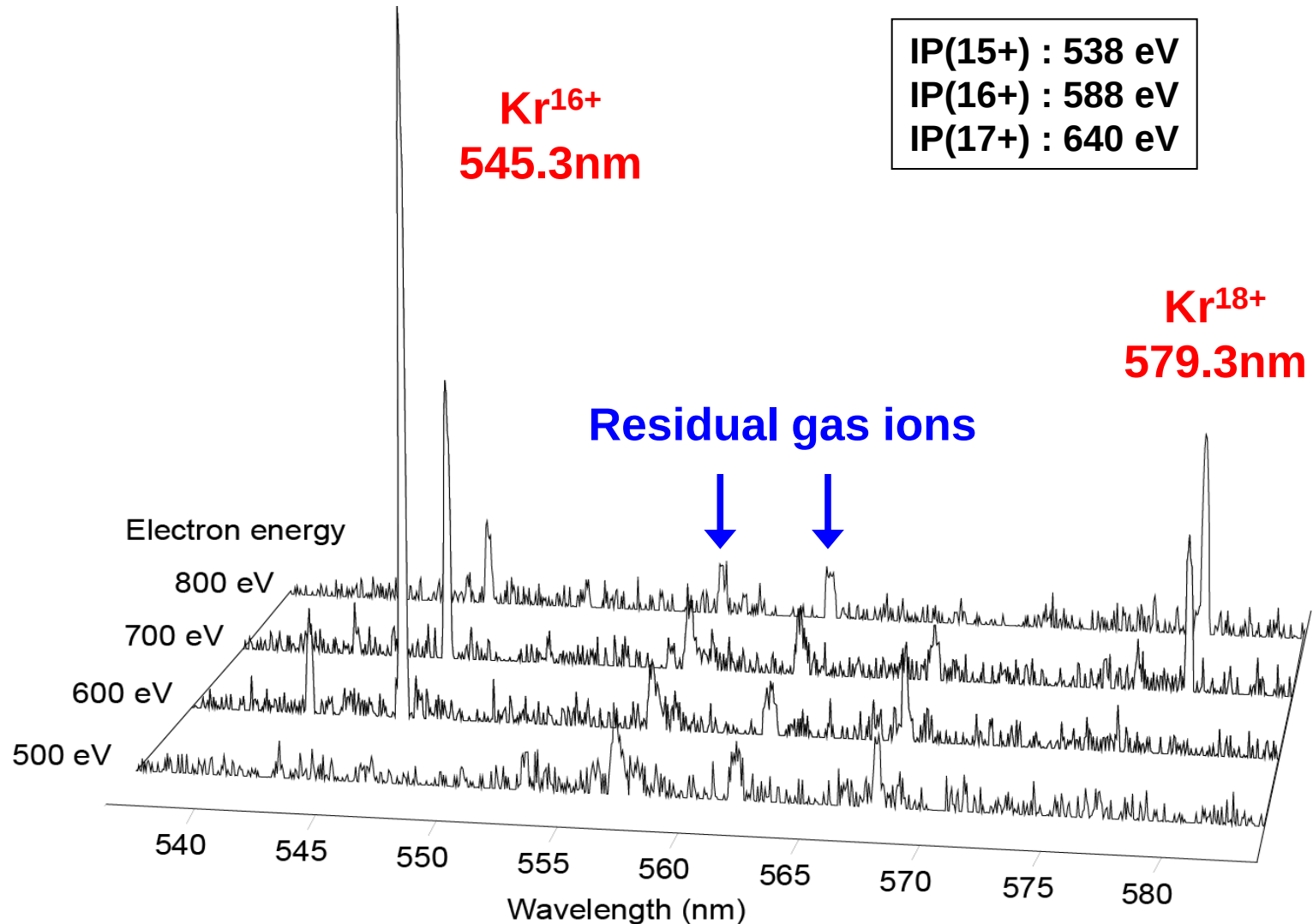
Running Reactor

ITER

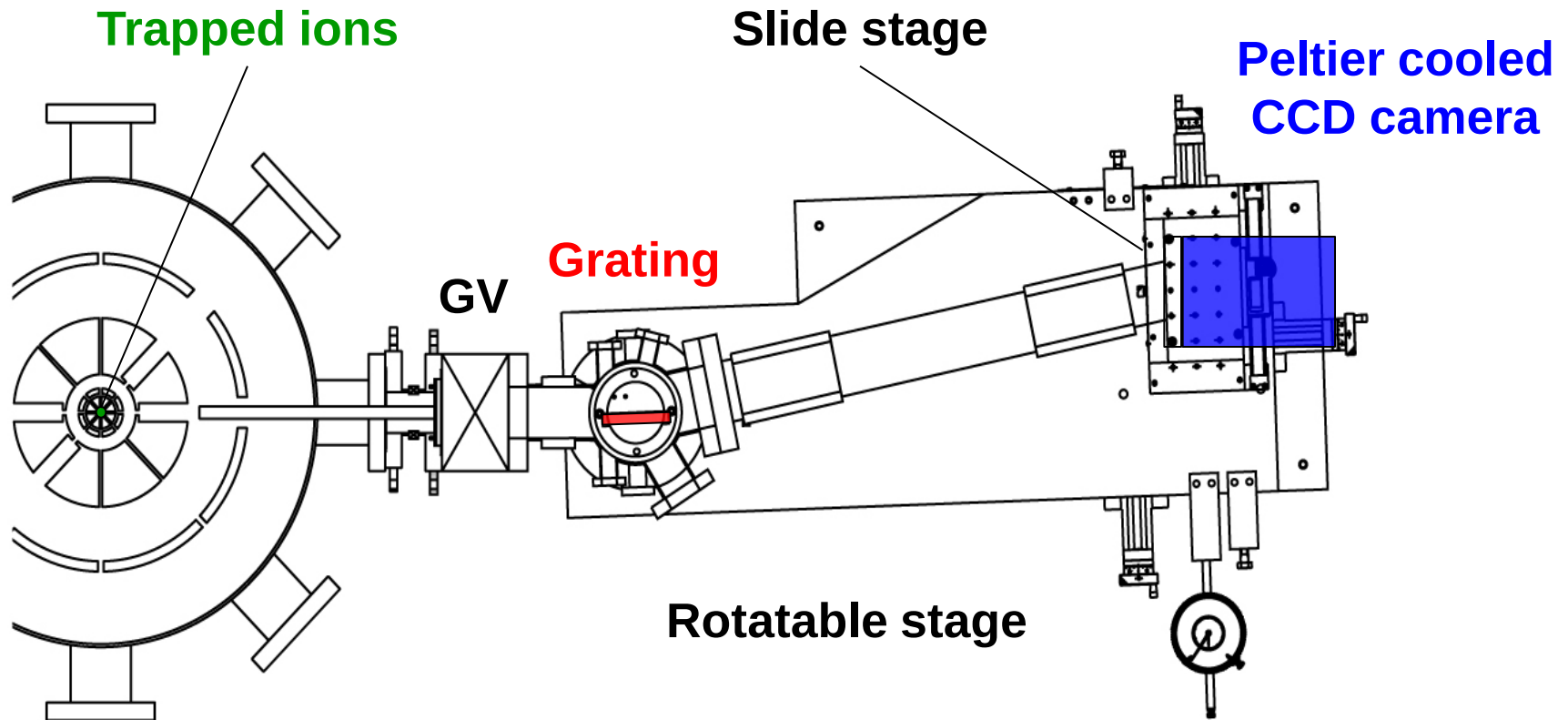
CoBIT

Tokyo-EBIT

What we can do using an EBIT?

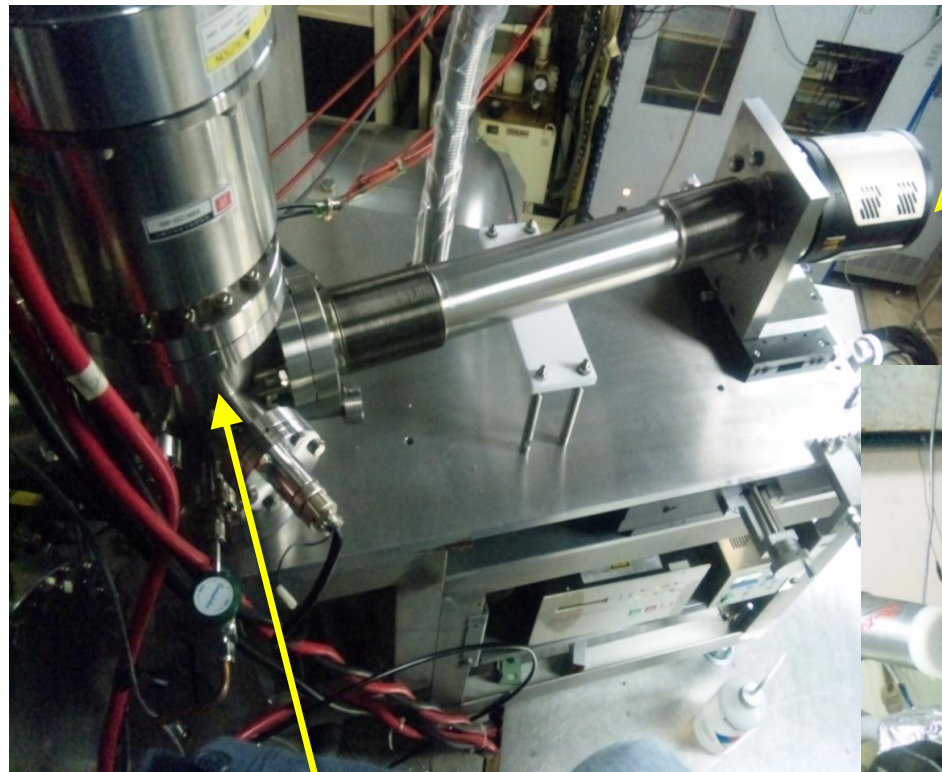


EUV spectrometer at the Tokyo-EBIT



Metallic Sn/Gd/Bi in a Knudsen cell @570–1100°C

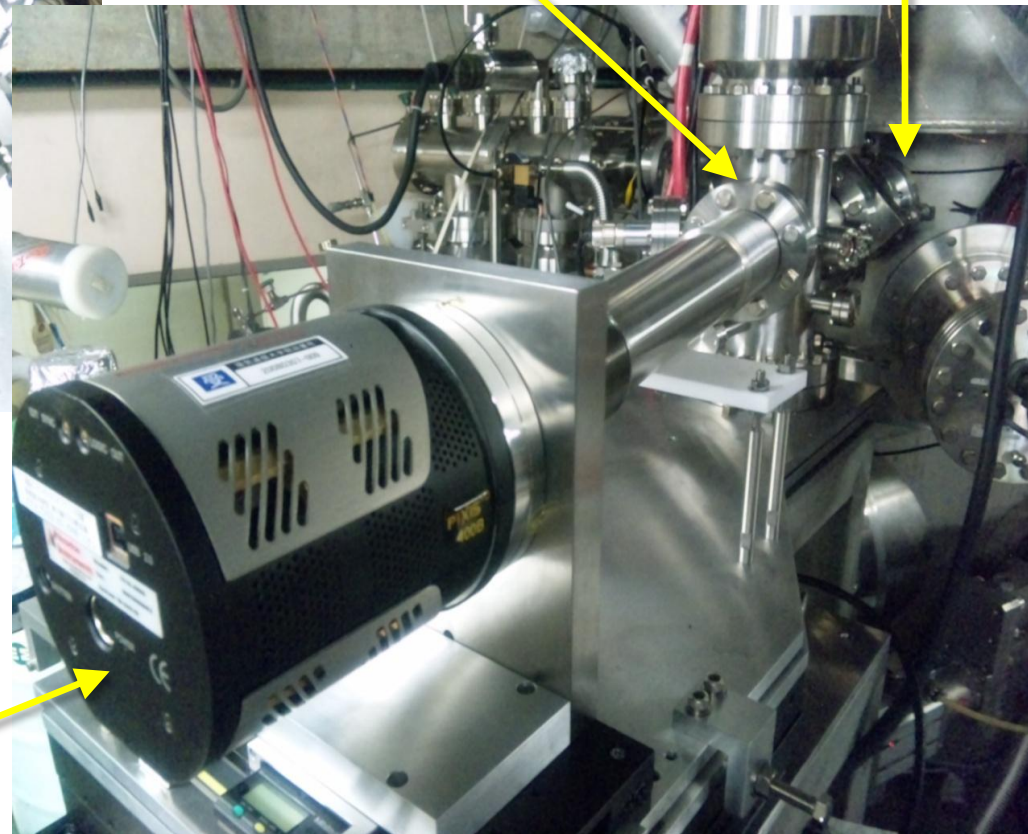
EUV spectrometer at the Tokyo-EBIT



Back-illuminated CCD

Tokyo-EBIT

Grating chamber

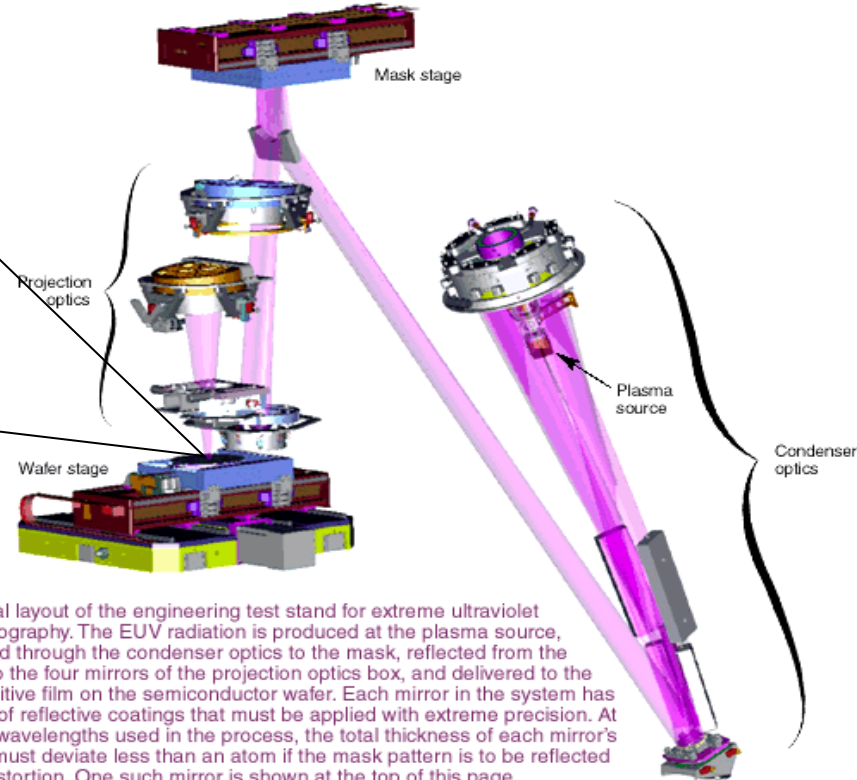
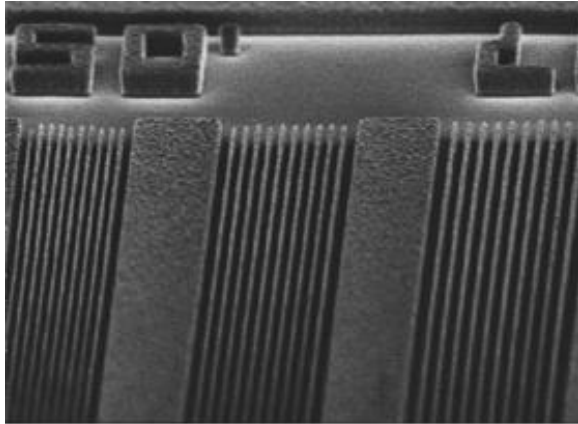


Grating chamber

Back-illuminated CCD

Sn ions

Semiconductor Photo-Lithography



The optical layout of the engineering test stand for extreme ultraviolet (EUV) lithography. The EUV radiation is produced at the plasma source, transmitted through the condenser optics to the mask, reflected from the mask onto the four mirrors of the projection optics box, and delivered to the EUV-sensitive film on the semiconductor wafer. Each mirror in the system has 81 layers of reflective coatings that must be applied with extreme precision. At the short wavelengths used in the process, the total thickness of each mirror's coatings must deviate less than an atom if the mask pattern is to be reflected without distortion. One such mirror is shown at the top of this page.

Resolution

$\propto$ **Exposure light wavelength**

Shorter wavelength

➔ **Highly** integrated

The optical layout of the engineering test stand for EUV lithography.

<http://www.llnl.gov/str/Sween.html>

Developments of the exposure light wavelength

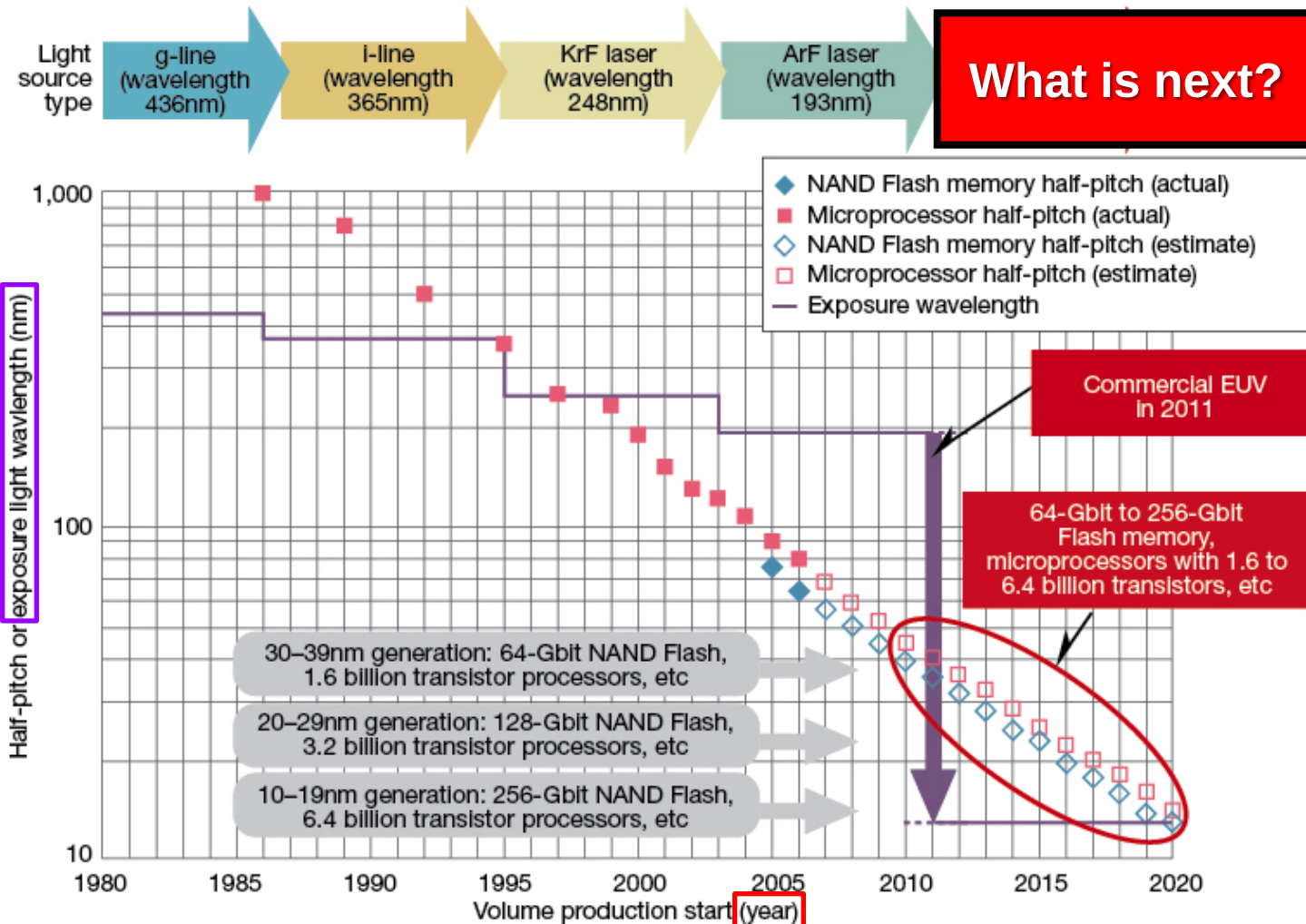
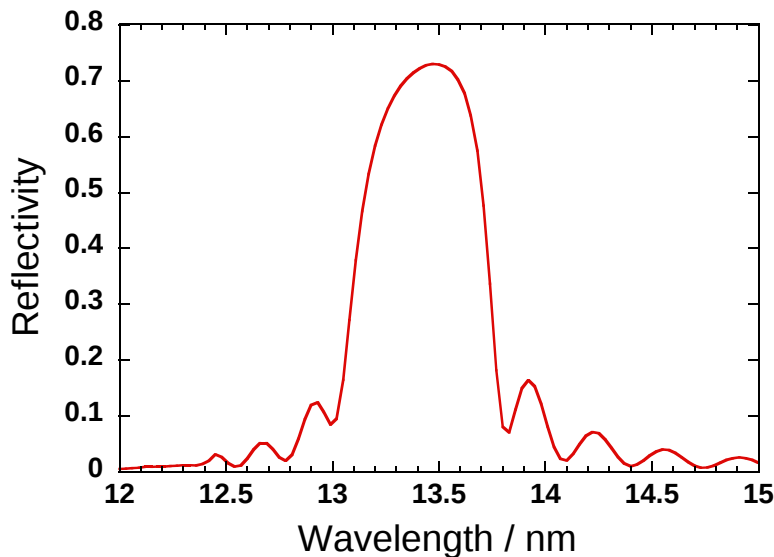


Fig 1 Slashing Lithography Wavelength to Drive Further Geometry Shrink EUV lithography has been pegged as a technology for the future, but it is approaching practical use fast. Diagram by *Nikkei Electronics* based on material from Intel, International Technology Roadmap for Semiconductors (ITRS), etc.

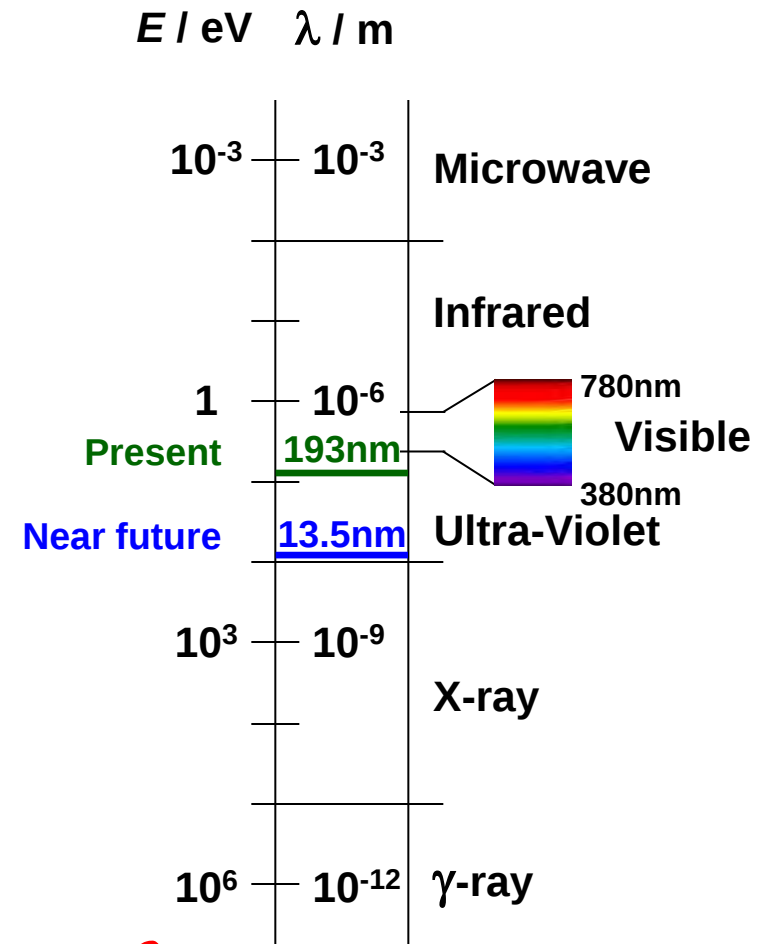
Extreme Ultra-Violet (EUV) Lithography

Exposure light Wavelength

Light Source $\Leftrightarrow$ Optical Mirror **Decided !**



Reflectivity of Mo/Si multi-layer mirror (MLM) for EUV lithography.

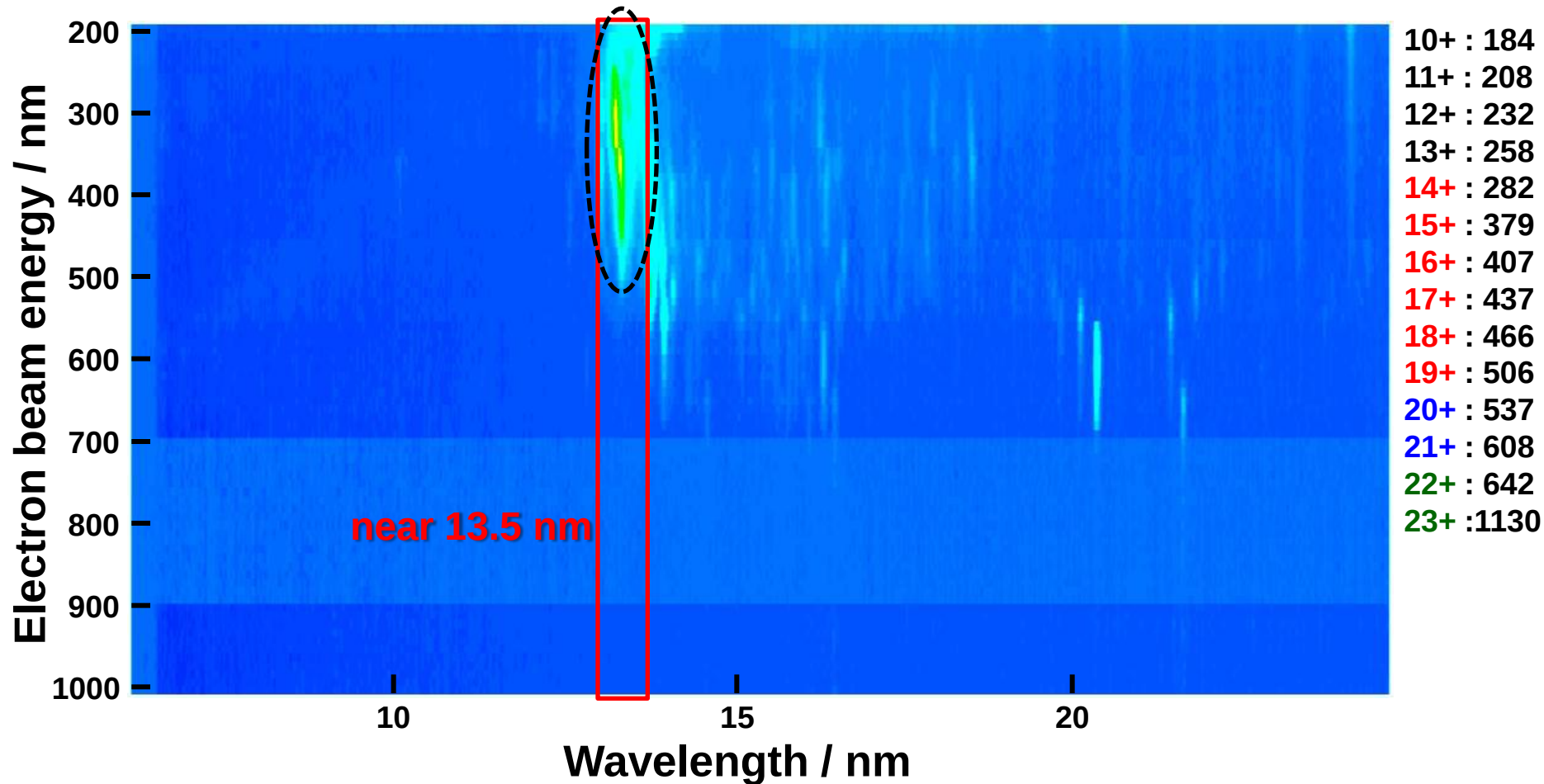


→ λ = 13.5 nm (91.9 eV) → **Candidates** $_3\text{Li}$, $_{50}\text{Sn}$ and $_{54}\text{Xe}$ plasmas

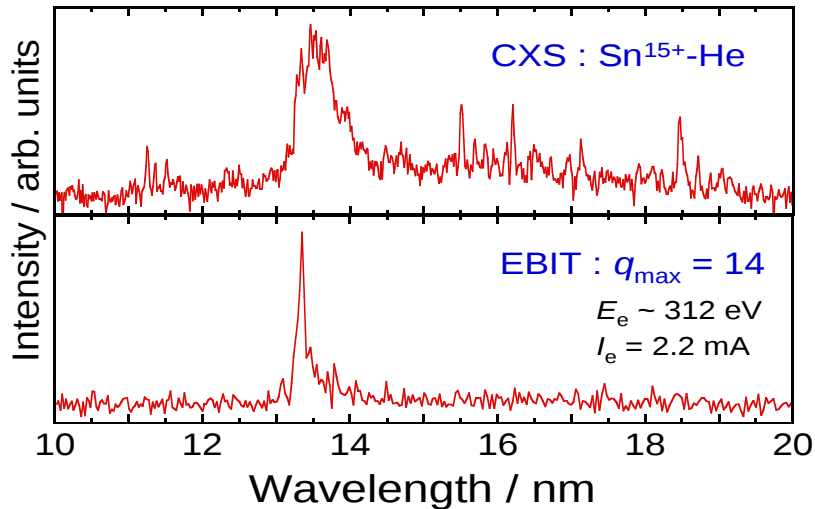
EUV emission spectra of Sn ions

Unresolved transition array (UTA)
of 4d-4f and 4p-4d transitions

IPs to produce each
charge state / eV



Complementary spectroscopy of Sn ions



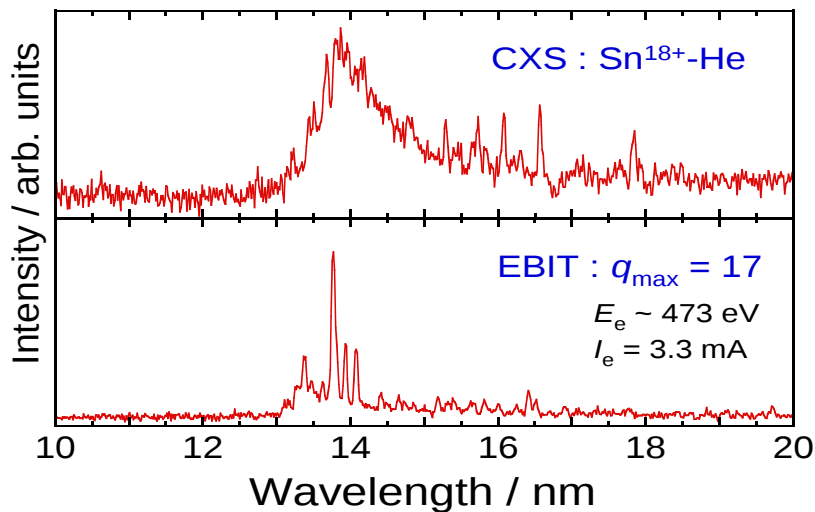
Charge exchange collision (CXS)

→ **Resonance line**

→ Transition between excited states

EBIT : electron impact

→ **Resonance line**



EBIT $\Leftrightarrow$ Charge exchange

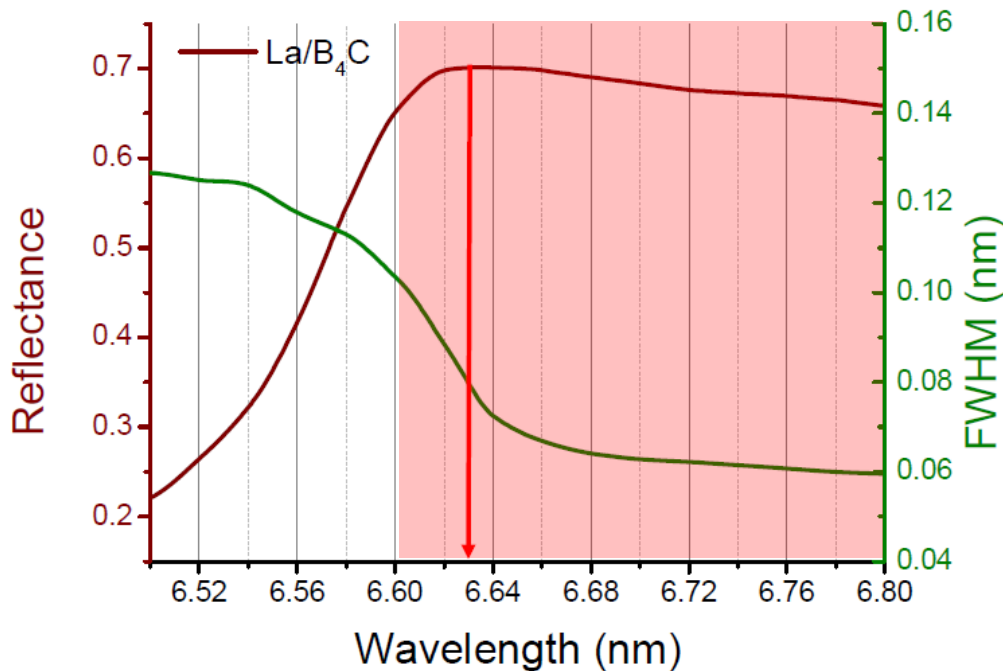
→ **Complementary Expt.**

Gd ions

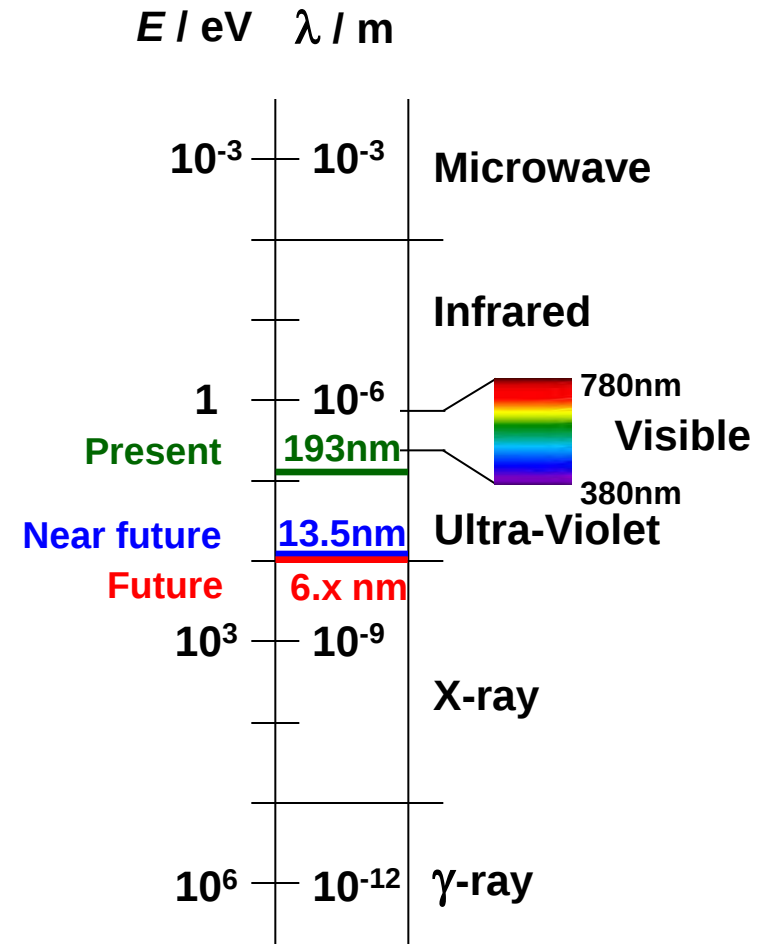
~~Beyond~~ Extreme Ultra-Violet (EUV) Lithography

Exposure light Wavelength

Light Source $\Leftrightarrow$ Optical Mirror



Calculated normal incidence reflectance and band width^{1, 2}



$\Rightarrow \lambda = 6.x \text{ nm} \Rightarrow$ Candidates $_{64}\text{Gd}$ and $_{65}\text{Tb}$ plasmas

Next-Generation EUV Lithography at 6.x nm

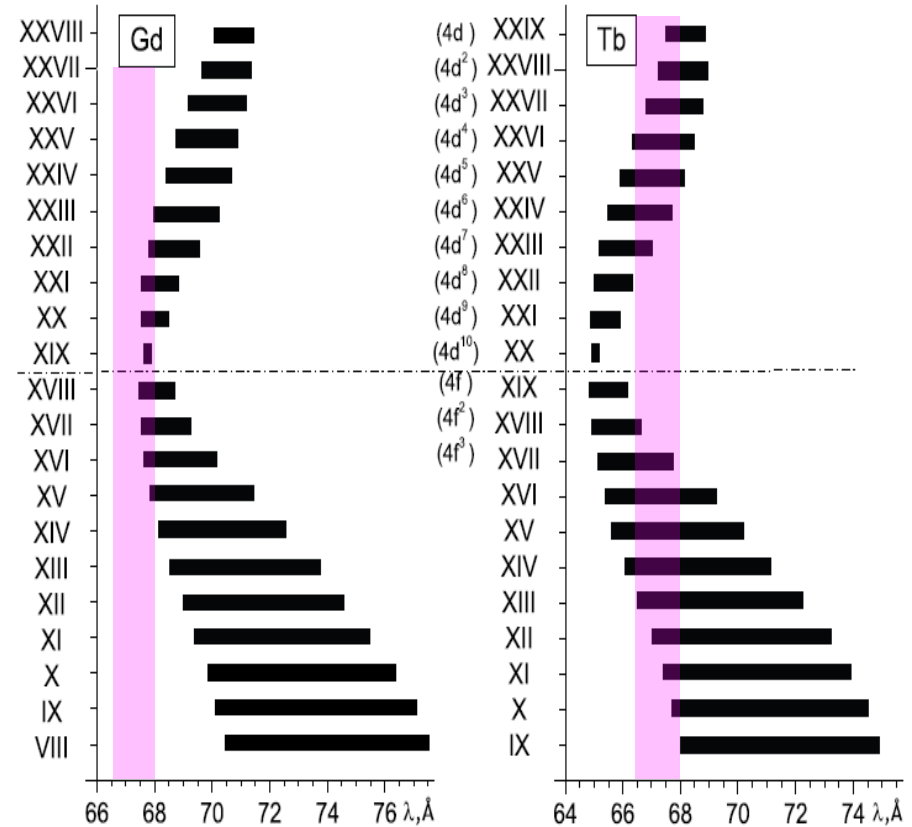
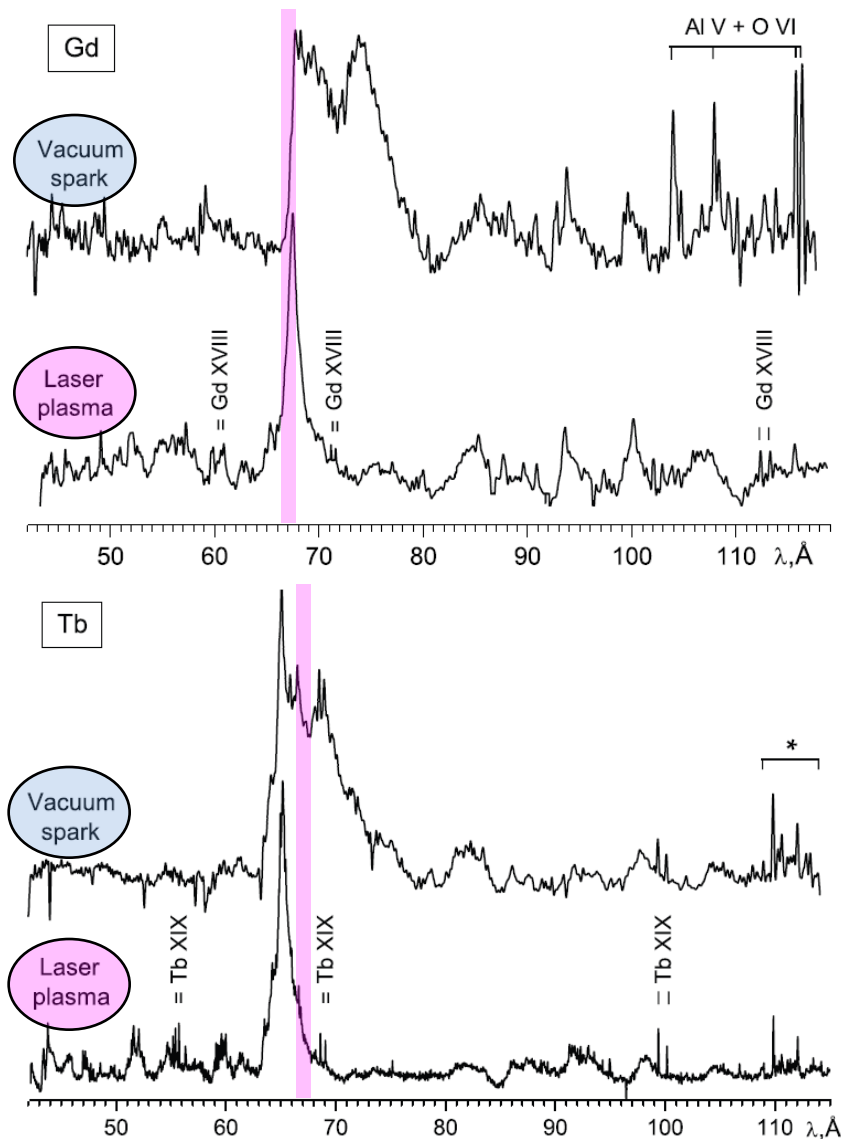


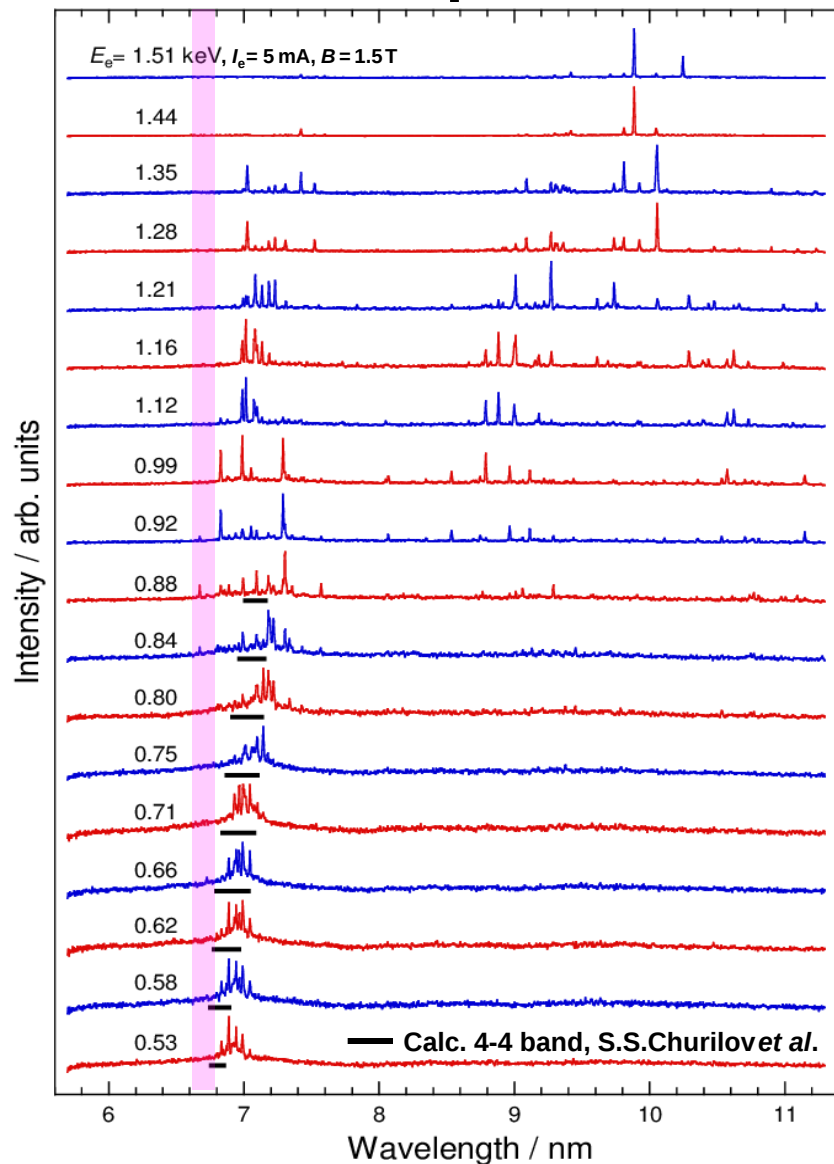
Figure 3. The calculated wavelength bands of the most intense 4-4 transition in the spectra of the rare-earth 4d- and 4f-ions.

Atomic data for each charge state is needed to understand and optimize the plasma!!

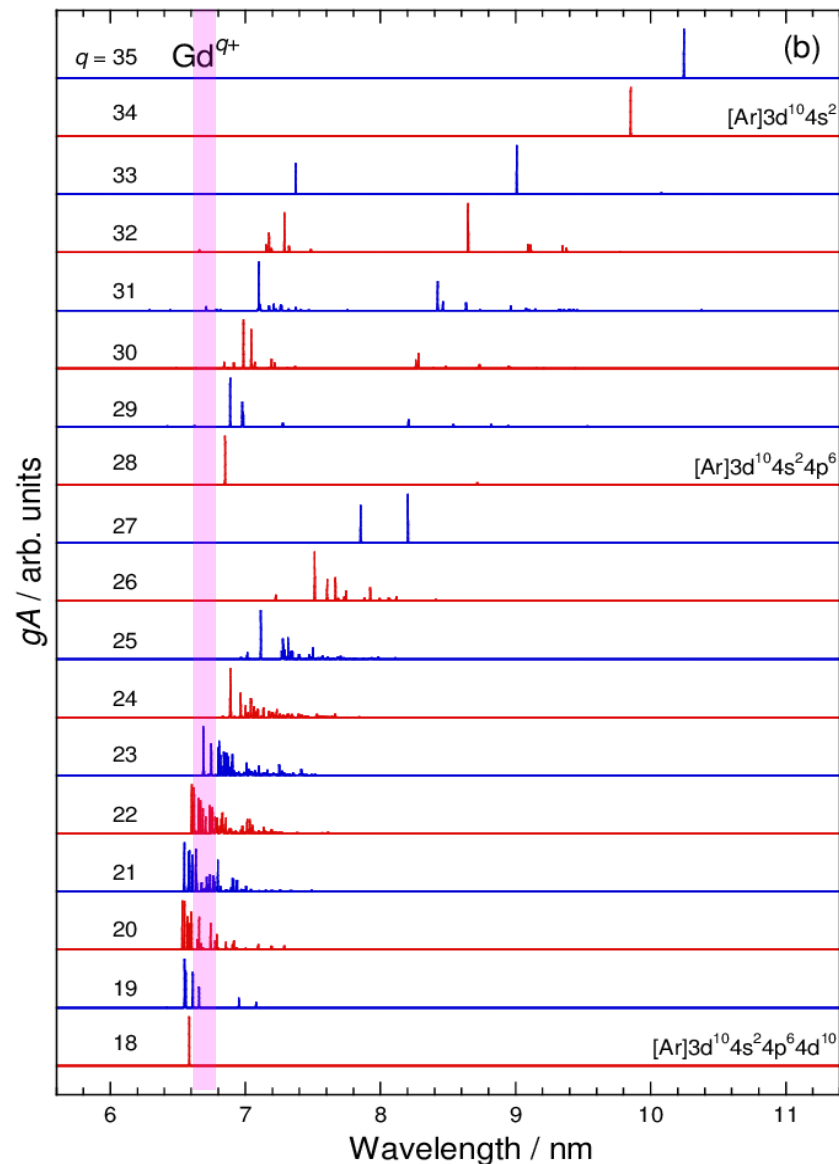
Atomic data accumulation!!

Electron beam energy dependence

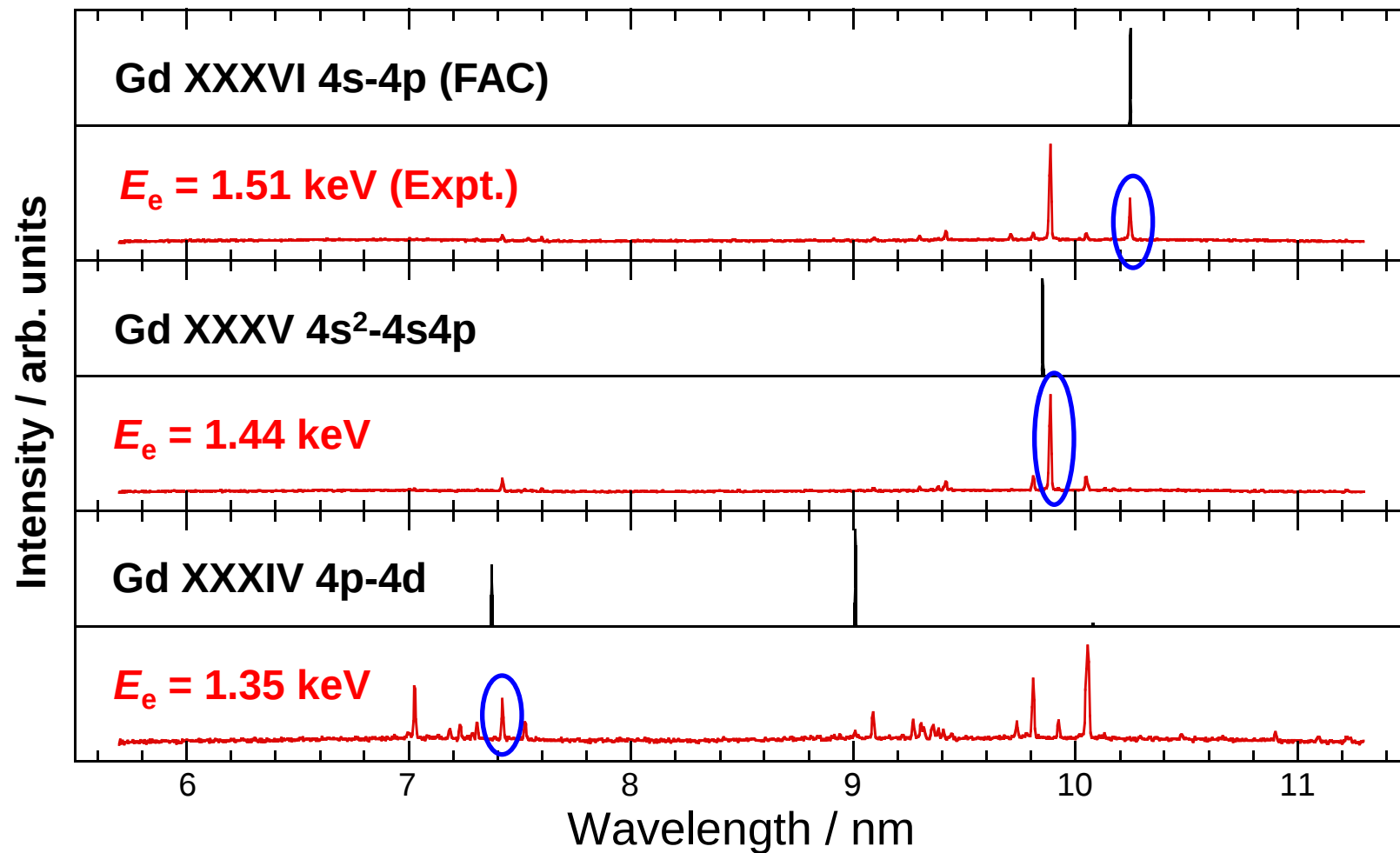
Expt.



Calc. with FAC



Identification of observed lines with FAC



Identification of observed lines with FAC

Ion	Sequence	Lower level		Upper level		Expt.wavelength / nm		Calc. / nm
		Conf.	State	Conf.	State	This work	Previous	FAC
Gd ³⁵⁺	Cu-like	4s	4s _{1/2}	4p	4p _{3/2}	10.246	10.2497(15) ¹ 10.2459(15) ² 10.243(3) ³	10.246
Gd ³⁴⁺	Zn-like	4s ²	(4s ²) ₀	4s4p	(4s4p) ₁	9.887	9.8824(20) ⁴ 9.8831(10) ⁵ 9.887(2) ⁶	9.850
Gd ³³⁺	Ga-like	4s ² 4p	4p _{1/2}	4s ² 4d	4d _{3/2}	7.421	7.414(20) ⁷	7.382

Under identification for other observed emission lines.

¹ J. Reader and G. Luther, Phys. Scr., 24 732 (1981)

² G. A. Doschek et al., J. Opt. Soc. Am. B, 5 243 (1988)

³ J. F. Seely et al., Phys. Rev. A, 40 5020 (1989)

⁴ C. M. Brown et al., At. Data Nucl. Data Tables, 58 203 (1994)

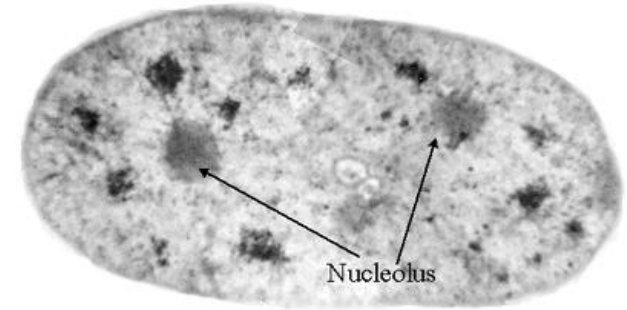
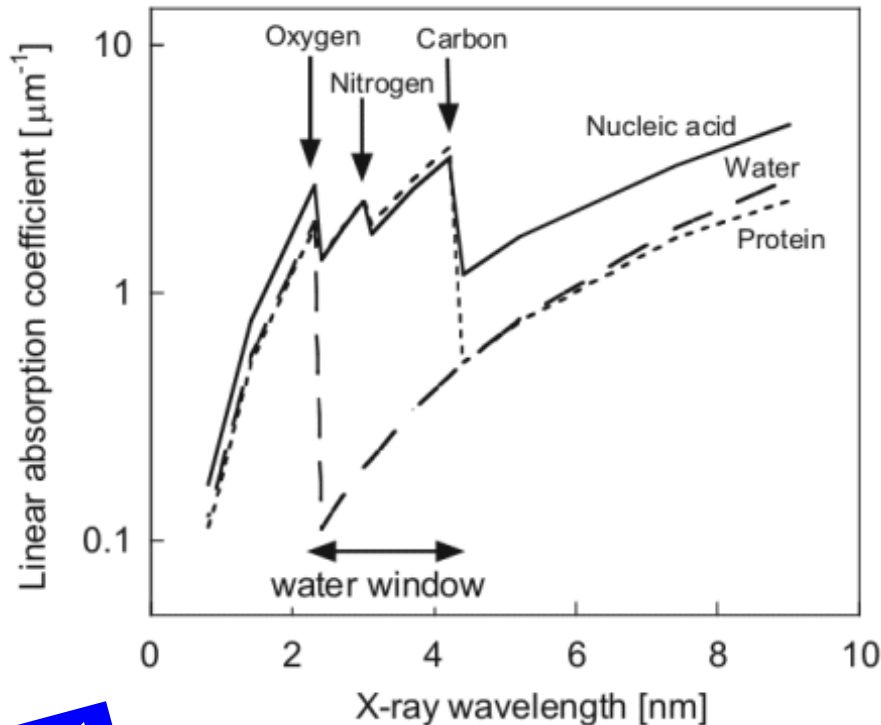
⁵ N. Acquista and J. Reader, J. Opt. Soc. Am. B, 1 649 (1984)

⁶ J. Reader and G. Luther, Phys. Rev. Lett., 45 609 (1980)

⁷ K. B. Fournier et al., Phys. Rev. A, 50 2248 (1994)

Bi ions

Water window & X-ray microscopy for *live* cell imaging



In vivo!!

<http://www.lbl.gov/Science-Articles/Archive/xray-inside-cells.html>

Present

Light Source: Synchrotrons or Free Electron Laser (FEL)
→ **Too big** and **not easy** to use

Future

Table-top (**laboratory-scale**) broadband emission source

LPP spectra of Bi ions

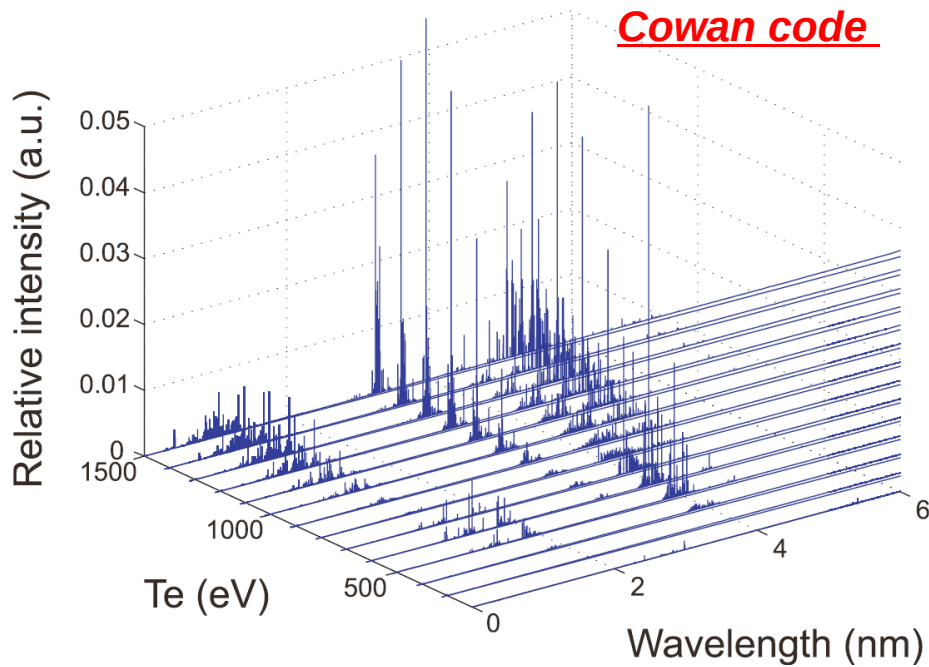


FIG. 2. (Color online) Calculated spectral variation as a function of electron temperature.

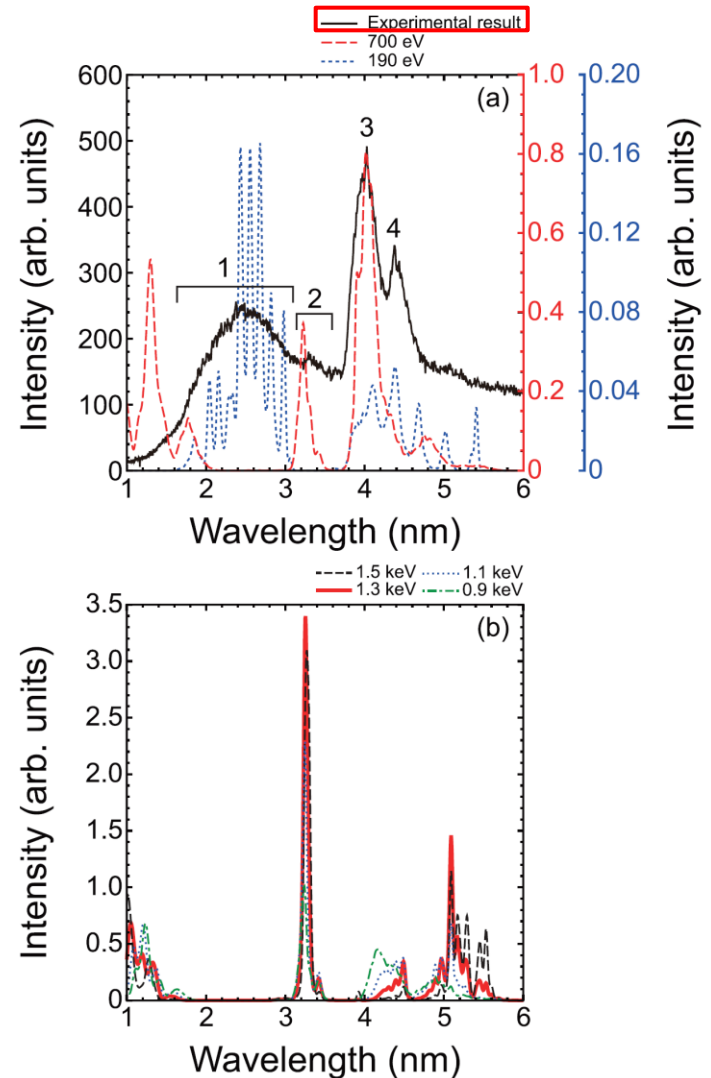


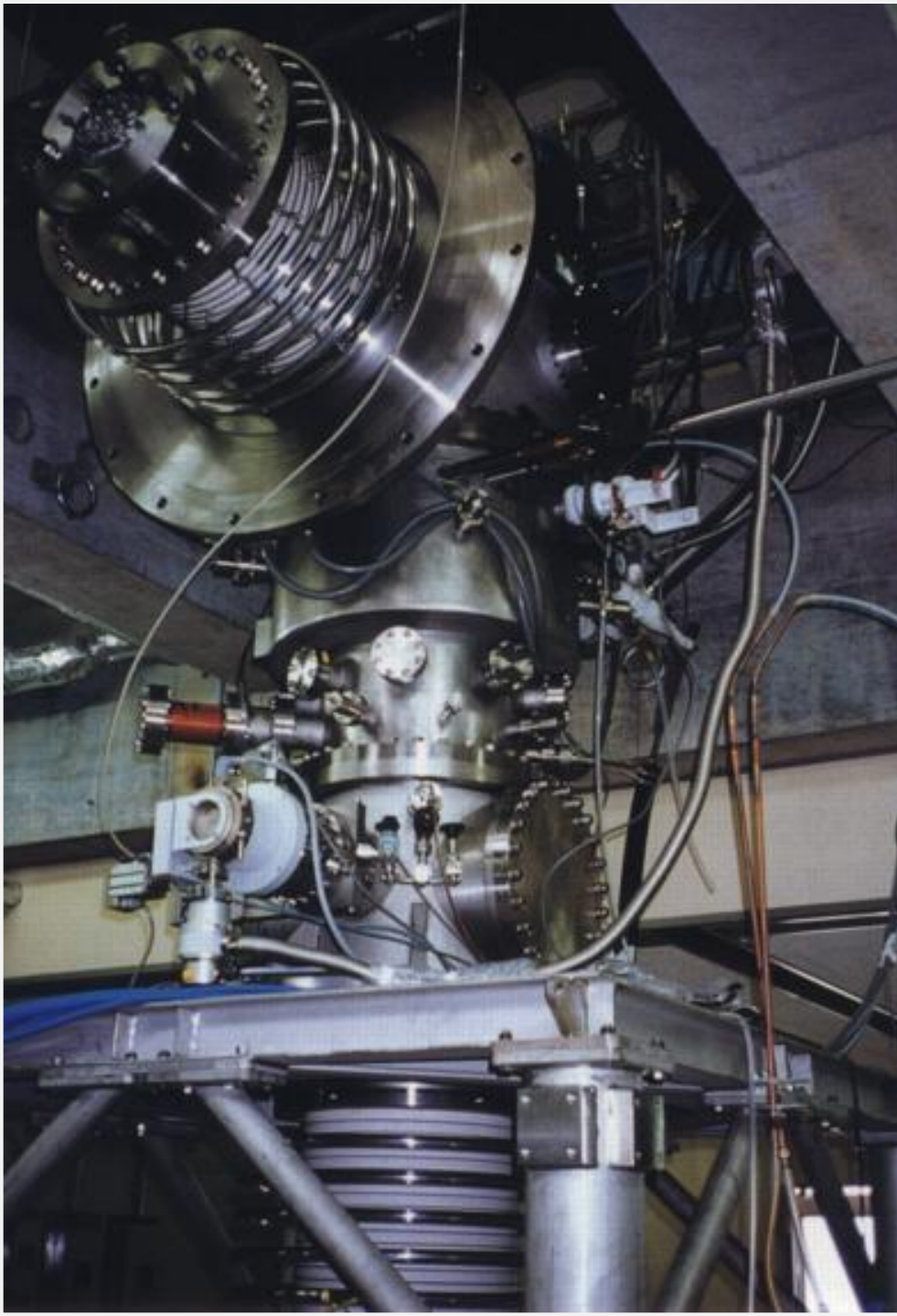
FIG. 4. (Color online) (a) The comparison between the observed spectrum with numerical calculation under assuming steady-state electron temperatures of 190 and 700 eV, respectively. (b) Calculated spectra for electron temperatures higher than 900 eV.

Summary

- **EUV emission spectroscopy** of $_{50}\text{Sn}$, $_{64}\text{Gd}$ and $_{83}\text{Bi}$ ions with an **EBIT**.
- **UTA** of **4d-4f** and **4p-4d** transitions contribute to main emissions for **EUV light sources**.
- **FAC Calc.** for line identification
 - discrepancy between Expt. and Calc.
- Comparison with other emission spectra in different Expt.

Outlook

- **Identification** of observed emission lines
- **Lower energy** Expt. using **CoBIT** (→ **Lower charge** states)
- **Charge exchange spectroscopy**
(→ Including **transitions between excited states**)
- **Terbium**($_{65}\text{Tb}$) for BEUVL, **Zirconium** ($_{40}\text{Zr}$) for water window



***Thank you for
your attention!!***

